Hex Gate

The MC14572UB hex functional gate is constructed with MOS P-channel and N-channel enhancement mode devices in a single monolithic structure. These complementary MOS logic gates find primary use where low power dissipation and/or high noise immunity is desired. The chip contains four inverters, one NOR gate and one NAND gate.

- Diode Protection on All Inputs
- Single Supply Operation
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- NOR Input Pin Adjacent to VSS Pin to Simplify Use As An Inverter
- NAND Input Pin Adjacent to VDD Pin to Simplify Use As An Inverter
- NOR Output Pin Adjacent to Inverter Input Pin For OR Application
- NAND Output Pin Adjacent to Inverter Input Pin For AND Application
- Capable of Driving Two Low–power TTL Loads or One Low–Power Schottky TTL Load over the Rated Temperature Range

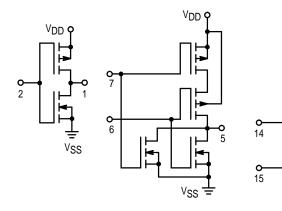
MAXIMUM RATINGS* (Voltages Referenced to VSS)

| Symbol | Parameter | Value | Unit |
|------------------------------------|--|--------------------------------|------|
| V_{DD} | DC Supply Voltage | - 0.5 to + 18.0 | V |
| V _{in} , V _{out} | Input or Output Voltage (DC or Transient) | – 0.5 to V _{DD} + 0.5 | V |
| I _{in} , I _{out} | Input or Output Current (DC or Transient), per Pin | ± 10 | mA |
| PD | Power Dissipation, per Package† | 500 | mW |
| T _{stg} | Storage Temperature | - 65 to + 150 | °C |
| TL | Lead Temperature (8–Second Soldering) | 260 | °C |

^{*} Maximum Ratings are those values beyond which damage to the device may occur. †Temperature Derating:

Plastic "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C Ceramic "L" Packages: – 12 mW/°C From 100°C To 125°C

CIRCUIT SCHEMATIC



MC14572UB



L SUFFIX CERAMIC CASE 620



P SUFFIX PLASTIC CASE 648



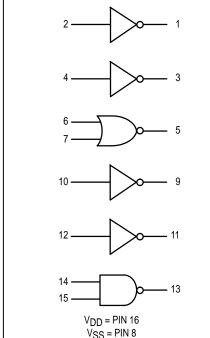
D SUFFIX SOIC CASE 751B

ORDERING INFORMATION

MC14XXXUBCP Plastic
MC14XXXUBCL Ceramic
MC14XXXUBD SOIC

 $T_A = -55^{\circ}$ to 125°C for all packages.

LOGIC DIAGRAM



ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

| Characteristic | | | V _{DD} | − 55°C | | 25°C | | | 125°C | | |
|---|-----------|------------------|------------------------|------------------------------------|----------------------|----------------------------------|---|----------------------|------------------------------------|----------------------|------|
| | | Symbol | Vdc | Min | Max | Min | Тур# | Max | Min | Max | Unit |
| Output Voltage V _{in} = V _{DD} or 0 | "0" Level | VOL | 5.0 10 15 | _ _ _ | 0.05 0.05 0.05 | _ _ _ | 0 0 0 | 0.05 0.05 0.05 | _ _ _ | 0.05 0.05 0.05 | Vdc |
| $V_{in} = 0$ or V_{DD} | "1" Level | VOH | 5.0 10 15 | 4.95 9.95 14.95 | _ _ _ | 4.95 9.95 14.95 | 5.0 10 15 | _ _ _ | 4.95 9.95 14.95 | _ _ _ | Vdc |
| Input Voltage (V _O = 4.5 or 0.5 Vdc) (V _O = 9.0 or 1.0 Vdc) (V _O = 13.5 or 1.5 Vdc) | "0" Level | V _I L | 5.0 10 15 | _ _ _ | 1.0 2.0 2.5 | | 2.25 4.50 6.75 | 1.0 2.0 2.5 | | 1.0 2.0 2.5 | Vdc |
| (V _O = 0.5 or 4.5 Vdc) (V _O = 1.0 or 9.0 Vdc) (V _O = 1.5 or 13.5 Vdc) | "1" Level | VIH | 5.0 10 15 | 4.0 8.0 12.5 | _ | 4.0 8.0 12.5 | 2.75 5.50 8.25 | _ | 4.0 8.0 12.5 | _ | Vdc |
| Output Drive Current (V _{OH} = 2.5 Vdc) (V _{OH} = 4.6 Vdc) (V _{OH} = 9.5 Vdc) (V _{OH} = 13.5 Vdc) | Source | ІОН | 5.0 5.0 10 15 | - 1.2 - 0.25 - 0.62 - 1.8 | _ _ _ _ | - 1.0 - 0.2 - 0.5 - 1.5 | - 1.7 - 0.36 - 0.9 - 3.5 | _ _ _ _ | - 0.7 - 0.14 - 0.35 - 1.1 | _ _ _ _ | mAdc |
| $(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$ | Sink | lOL | 5.0 10 15 | 0.64 1.6 4.2 | _ _ _ | 0.51 1.3 3.4 | 0.88 2.25 8.8 | _ _ _ | 0.36 0.9 2.4 | _ _ _ | mAdc |
| Input Current | | l _{in} | 15 | _ | ±0.1 | _ | ±0.00001 | ±0.1 | _ | ±1.0 | μAdc |
| Input Capacitance (V _{in} = 0) | | C _{in} | _ | _ | _ | _ | 5.0 | 7.5 | _ | _ | pF |
| Quiescent Current (Per Package) | | I _{DD} | 5.0 10 15 | _ _ _ | 0.25 0.5 1.0 | <u> </u> | 0.0005 0.0010 0.0015 | 0.25 0.5 1.0 | _ _ _ | 7.5 15 30 | μAdc |
| Total Supply Current**† (Dynamic plus Quiescent, Per Package) (C _L = 50 pF on all outputs, all buffers switching) | | lΤ | 5.0 10 15 | | | $I_{T} = (3)$ | .89 μΑ/kHz) .80 μΑ/kHz) .68 μΑ/kHz) | f + I _{DD} | • | | μAdc |

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$$

where: I_T is in μA (per package), C_L in pF, $V = (V_{DD} - V_{SS})$ in volts, f in kHz is input frequency, and k = 0.006.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}.$ Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

PIN ASSIGNMENT OUT_A INA 15 IN 2_F 14 | IN 1_F OUT_B [IN_B [13 DUT_F OUT_C [12] INE IN 1_C 11 OUTE IN 2_C 10 9 DUTD VSS [

^{**}The formulas given are for the typical characteristics only at 25 $^{\circ}\text{C}.$

[†]To calculate total supply current at loads other than 50 pF:

SWITCHING CHARACTERISTICS* ($C_L = 50 \text{ pF}, T_A = 25^{\circ}C$)

| Characteristic | Symbol | V _{DD} | Min | Тур# | Max | Unit |
|--|--|-----------------|-------------|-----------------|-------------------|------|
| Output Rise Time $t_{TLH} = (3.0 \text{ ns/pF}) \text{ C}_L + 30 \text{ ns}$ $t_{TLH} = (1.5 \text{ ns/pF}) \text{ C}_L + 15 \text{ ns}$ $t_{TLH} = (1.1 \text{ ns/pF}) \text{ C}_L + 10 \text{ ns}$ | ^t TLH | 5.0 10 15 | | 180 90 65 | 360 180 130 | ns |
| Output Fall Time t _{THL} = (1.5 ns/pF) C _L + 25 ns t _{THL} = (0.75 ns/pF) C _L + 12.5 ns t _{THL} = (0.55 ns/pF) C _L + 9.5 ns | [†] THL | 5.0 10 15 | _ _ _ | 100 50 40 | 200 100 80 | ns |
| Propagation Delay Time tp_H, tpHL = (1.7 ns/pF) C _L + 5 ns tp_H, tpHL = (0.66 ns/pF) C _L + 17 ns tp_H, tpHL = (0.5 ns/pF) C _L + 15 ns | t _{PLH} , t _{PHL} | 5.0 10 15 | _ _ _ | 90 50 40 | 180 100 80 | ns |

^{*} The formulas given are for the typical characteristics only at 25°C.

[#]Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

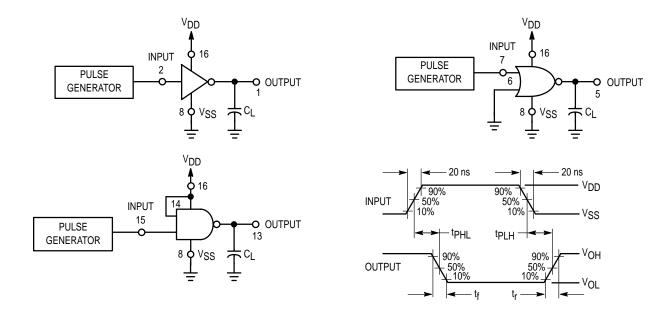
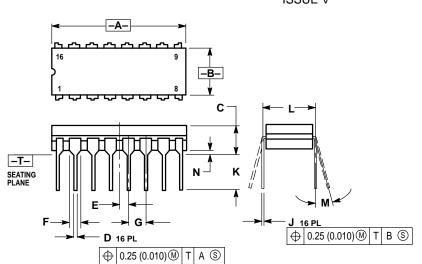


Figure 1. Switching Time Test Circuits and Waveforms

OUTLINE DIMENSIONS

L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE V



NOTES:

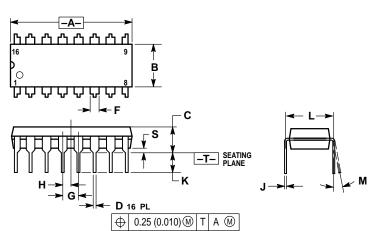
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

- ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 DIMENSION L TO CENTER OF LEAD WHEN
 FORMED PARALLEL.
 DIMENSION F MAY NARROW TO 0.76 (0.030)
 WHERE THE LEAD ENTERS THE CERAMIC

| | INC | HES | MILLIN | IETERS | |
|-----|-------|-------|----------|--------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.750 | 0.785 | 19.05 | 19.93 | |
| В | 0.240 | 0.295 | 6.10 | 7.49 | |
| С | | 0.200 | | 5.08 | |
| D | 0.015 | 0.020 | 0.39 | 0.50 | |
| Е | 0.050 | BSC | 1.27 BSC | | |
| F | 0.055 | 0.065 | 1.40 | 1.65 | |
| G | 0.100 |) BSC | 2.54 BSC | | |
| Н | 0.008 | 0.015 | 0.21 | 0.38 | |
| K | 0.125 | 0.170 | 3.18 | 4.31 | |
| L | 0.300 |) BSC | 7.62 | BSC | |
| М | 0° | 15° | 0 ° | 15° | |
| N | 0.020 | 0.040 | 0.51 | 1.01 | |

P SUFFIX

PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

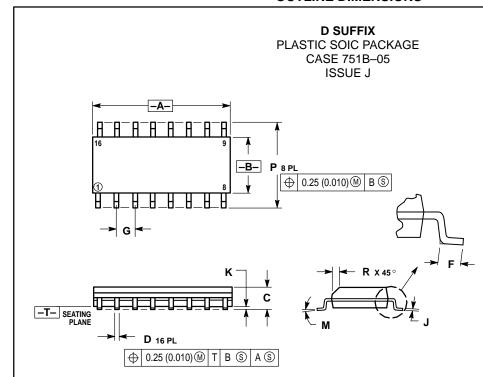
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

 5. ROUNDED CORNERS OPTIONAL.

| | INC | HES | MILLIMETERS | | | |
|-----|-------|-------|-------------|-------|--|--|
| DIM | MIN | MAX | MIN | MAX | | |
| Α | 0.740 | 0.770 | 18.80 | 19.55 | | |
| В | 0.250 | 0.270 | 6.35 | 6.85 | | |
| С | 0.145 | 0.175 | 3.69 | 4.44 | | |
| D | 0.015 | 0.021 | 0.39 | 0.53 | | |
| F | 0.040 | 0.70 | 1.02 | 1.77 | | |
| G | 0.100 | BSC | 2.54 BSC | | | |
| Н | 0.050 | BSC | 1.27 BSC | | | |
| J | 0.008 | 0.015 | 0.21 | 0.38 | | |
| K | 0.110 | 0.130 | 2.80 | 3.30 | | |
| L | 0.295 | 0.305 | 7.50 | 7.74 | | |
| M | 0° | 10° | 0° | 10 ° | | |
| S | 0.020 | 0.040 | 0.51 | 1.01 | | |

OUTLINE DIMENSIONS



- DIMENSIONING AND TOLERANCING PER ANSI
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE
- MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
 PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| | MILLIN | METERS | INCHES | | |
|-----|----------|---------|-----------|-------|--|
| DIM | MIN | MIN MAX | | MAX | |
| Α | 9.80 | 10.00 | 0.386 | 0.393 | |
| В | 3.80 | 4.00 | 0.150 | 0.157 | |
| С | 1.35 | 1.75 | 0.054 | 0.068 | |
| D | 0.35 | 0.49 | 0.014 | 0.019 | |
| F | 0.40 | 1.25 | 0.016 | 0.049 | |
| G | 1.27 BSC | | 0.050 BSC | | |
| J | 0.19 | 0.25 | 0.008 | 0.009 | |
| K | 0.10 | 0.25 | 0.004 | 0.009 | |
| M | 0° | 7° | 0° | 7° | |
| Р | 5.80 | 6.20 | 0.229 | 0.244 | |
| R | 0.25 | 0.50 | 0.010 | 0.019 | |

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